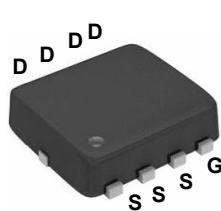
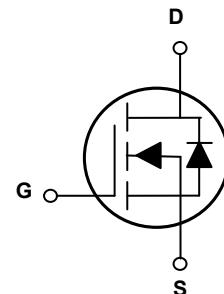


## Main Product Characteristics

$V_{(BR)DSS}$	40V
$R_{DS(ON)}$	6.8mΩ
$I_D$	60A



PPAK3x3



Schematic Diagram

## Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



## Description

The SSFN4964 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

## Absolute Maximum Ratings ( $T_C=25^\circ C$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	$V_{DS}$	40	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous ( $T_c=25^\circ C$ )	$I_D$	60	A
Drain Current-Continuous ( $T_c=100^\circ C$ )		38	
Drain Current-Pulsed <sup>1</sup>	$I_{DM}$	240	A
Single Pulse Avalanche Energy <sup>2</sup>	$E_{AS}$	76	mJ
Single Pulse Avalanche Current <sup>2</sup>	$I_{AS}$	39	A
Power Dissipation ( $T_c=25^\circ C$ )	$P_D$	51	W
Power Dissipation-Derate above $25^\circ C$		0.41	W/ $^\circ C$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62	$^\circ C/W$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.44	$^\circ C/W$
Operating Junction Temperature Range	$T_J$	-55 To +150	$^\circ C$
Storage Temperature Range	$T_{STG}$	-55 To +150	$^\circ C$

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>On/Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	40	-	-	V
Bv <sub>DSS</sub> Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	Reference to $25^\circ\text{C}$ , $\text{I}_D=1\text{mA}$	-	0.03	-	$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current	$\text{I}_{\text{DS}(\text{SS})}$	$\text{V}_{\text{DS}}=40\text{V}, \text{V}_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$	-	-	1	$\mu\text{A}$
		$\text{V}_{\text{DS}}=32\text{V}, \text{V}_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$	-	-	10	$\mu\text{A}$
Gate-Source Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm 20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
Static Drain-Source On-Resistance <sup>3</sup>	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=10\text{A}$	-	5.7	6.8	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=5\text{A}$	-	7	9	
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}, \text{I}_D=250\mu\text{A}$	1.2	1.6	2.5	V
$\text{V}_{\text{GS}(\text{th})}$ Temperature Coefficient	$\Delta \text{V}_{\text{GS}(\text{th})}$		-	-5	-	$\text{mV}/^\circ\text{C}$
Forward Transconductance	$\text{g}_{\text{fs}}$	$\text{V}_{\text{DS}}=10\text{V}, \text{I}_D=3\text{A}$	-	12	-	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge <sup>3,4</sup>	$\text{Q}_g$	$\text{V}_{\text{DS}}=20\text{V}, \text{I}_D=30\text{A}, \text{V}_{\text{GS}}=10\text{V}$	-	32	48	nC
Gate-Source Charge <sup>3,4</sup>	$\text{Q}_{\text{gs}}$		-	4	6	
Gate-Drain Charge <sup>3,4</sup>	$\text{Q}_{\text{gd}}$		-	10	15	
Turn-On Delay Time <sup>3,4</sup>	$\text{t}_{\text{d}(\text{on})}$	$\text{V}_{\text{DD}}=20\text{V}, \text{R}_G=6\Omega, \text{V}_{\text{GS}}=10\text{V}, \text{I}_D=30\text{A}$	-	13.6	20.4	nS
Rise Time <sup>3,4</sup>	$\text{t}_r$		-	2.5	3.8	
Turn-Off Delay Time <sup>3,4</sup>	$\text{t}_{\text{d}(\text{off})}$		-	68	102	
Fall Time <sup>3,4</sup>	$\text{t}_f$		-	5	7.5	
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=20\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{F}=1\text{MHz}$	-	1780	2670	pF
Output Capacitance	$\text{C}_{\text{oss}}$		-	185	275	
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		-	150	220	
Gate Resistance	$\text{R}_g$	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=0\text{V}, \text{F}=1\text{MHz}$	-	1.4	-	$\Omega$
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Continuous Source Current	$\text{I}_s$	$\text{V}_G=\text{V}_D=0\text{V}, \text{Force Current}$	-	-	60	A
Pulsed Source Current <sup>3</sup>	$\text{I}_{\text{SM}}$		-	-	120	A
Diode Forward Voltage <sup>3</sup>	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=1\text{A}, T_J=25^\circ\text{C}$	-	-	1	V
Reverse Recovery Time	$\text{t}_{\text{rr}}$	$\text{V}_R=30\text{V}, \text{I}_s=10\text{A}, \text{di/dt}=100\text{A}/\mu\text{s}, T_J=25^\circ\text{C}$	-	40	-	nS
Reverse Recovery Charge	$\text{Q}_{\text{rr}}$		-	20	-	nC

Note:

1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
2.  $\text{V}_{\text{DD}}=25\text{V}, \text{V}_{\text{GS}}=10\text{V}, \text{L}=0.1\text{mH}, \text{I}_{\text{AS}}=39\text{A}$ , Starting  $T_J=25^\circ\text{C}$ .
3. Pulse test: pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.

## Typical Electrical and Thermal Characteristic Curves

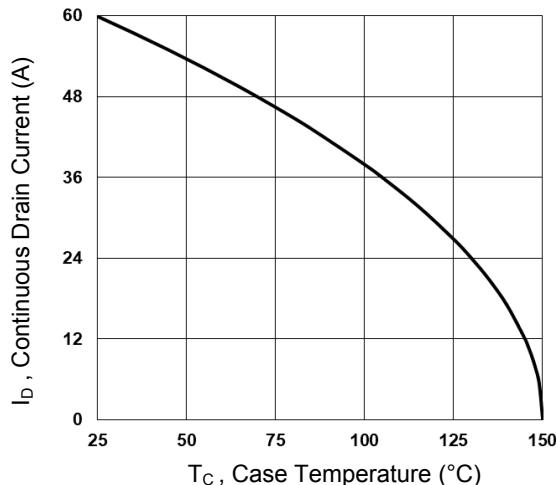


Figure 1. Continuous Drain Current vs. T<sub>c</sub>

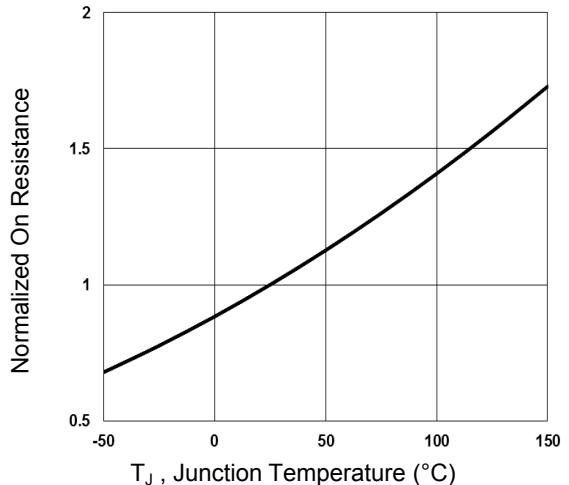


Figure 2. Normalized R<sub>DS(ON)</sub> vs. T<sub>j</sub>

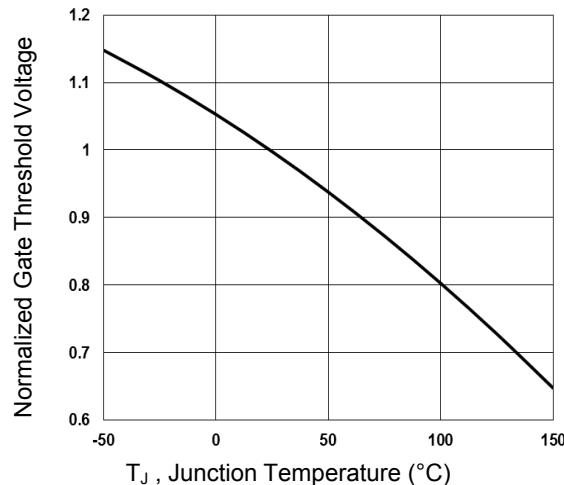


Figure 3. Normalized V<sub>th</sub> vs. T<sub>j</sub>

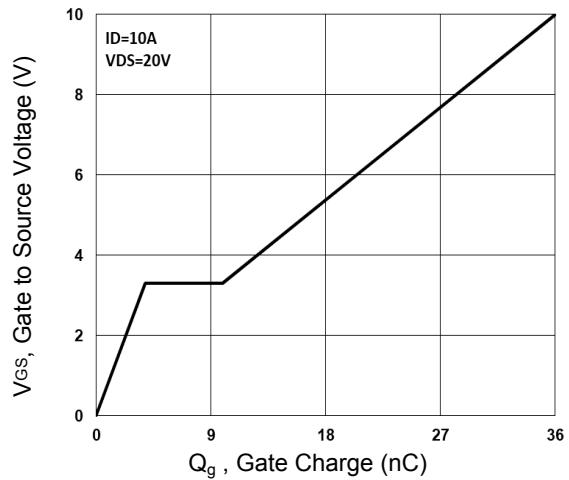


Figure 4. Gate Charge Waveform

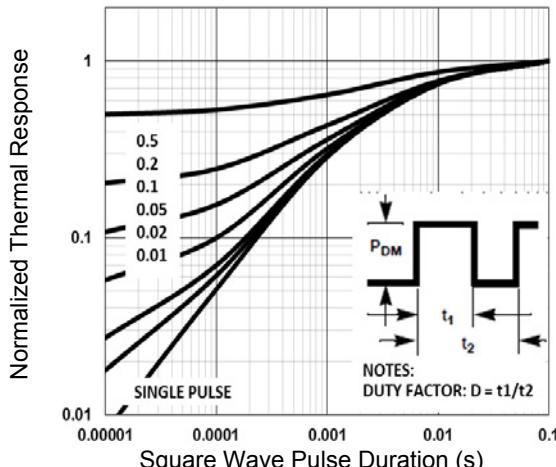


Figure 5. Normalized Transient Impedance

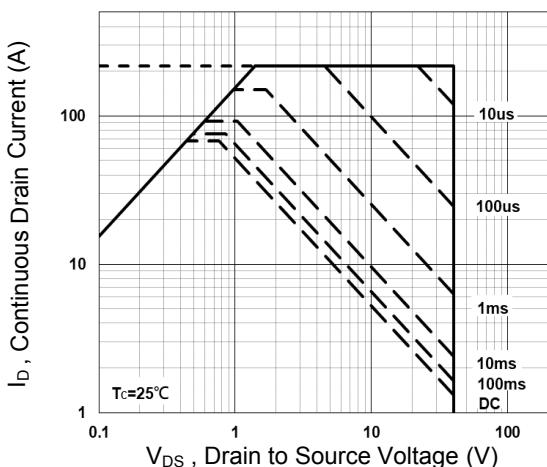


Figure 6. Maximum Safe Operation Area

## Typical Electrical and Thermal Characteristic Curves

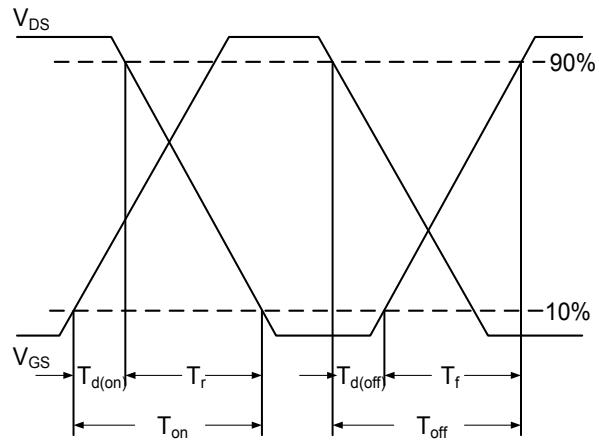


Figure 7. Switching Time Waveform

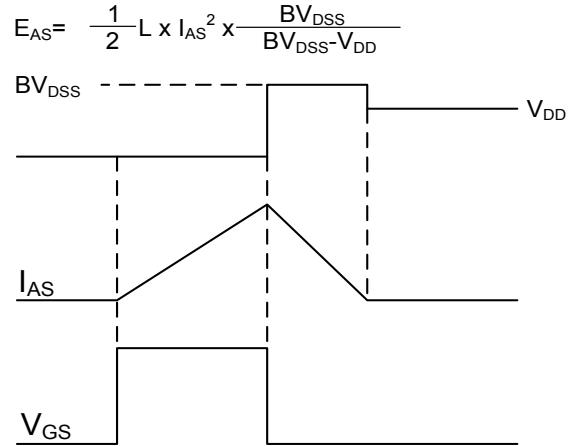
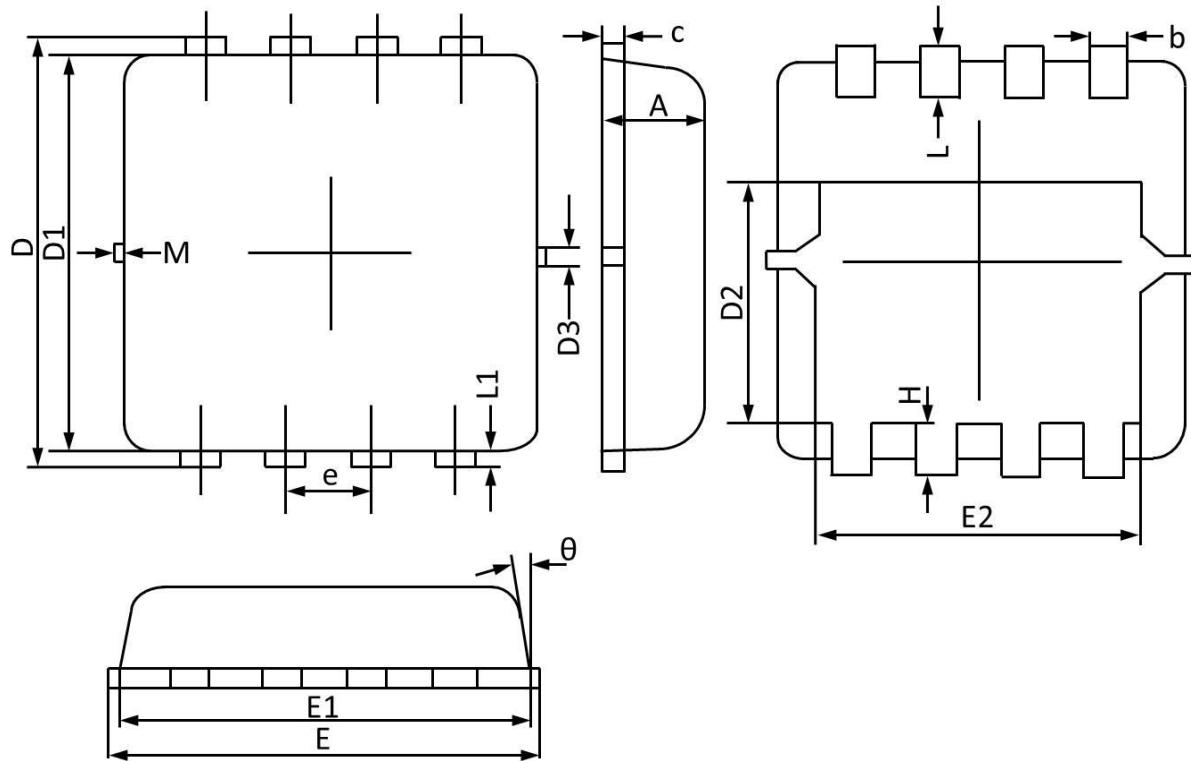


Figure 8. EAS Waveform

### Package Outline Dimensions

**PPAK3x3**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
b	0.250	0.350	0.010	0.013
c	0.100	0.250	0.004	0.009
D	3.250	3.450	0.128	0.135
D1	3.000	3.200	0.119	0.125
D2	1.780	1.980	0.070	0.077
D3	0.130 REF		0.005 REF	
E	3.200	3.400	0.126	0.133
E1	3.000	3.200	0.119	0.125
E2	2.390	2.590	0.094	0.102
e	0.650 BSC		0.026 BSC	
H	0.300	0.500	0.011	0.019
L	0.300	0.500	0.011	0.019
L1	0.130 REF		0.005 REF	
θ	0°	12°	0°	12°
M	0.150 REF		0.006 REF	